

ISEEIE 2023



Hangzhou, China
June 30–July 2, 2023

2023 3rd International Symposium on Electrical,
Electronics and Information Engineering

CALL FOR PAPER

Topics

(include but not limited to the following):

Electrical and Electronics Engineering

- Automation and Control Engineering
- Circuits and Systems
- Computer network and Security
- Computer-aided Design and Manufacturing
- Electric Vehicle Technologies
- Electrotechnologies

Information Engineering

- Artificial Intelligence
- Bioinformatic
- Computational optics
- Computer and Information Science
- Computer Graphics and Image Processing
- Computer Science and Engineering

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Publication

ISEEIE 2023 conference proceedings will be published as Digital Conference Proceedings. All accepted and presented full papers will be submitted to major citation databases like EI Compendex, SCOPUS, Google Scholar for reviewing and indexing.

Selected papers will be considered for submission in journal **Mathematics**, **Processes** and **Frontiers in Mechanical Engineering** after significant extension.

Submission

1. Submitted papers should be written in English, including all figures, tables, references, and appendices;
2. Ordinary length limits is 5–12 pages;
3. Manuscript Contents: Title, Introduction, Description, Methods, Tables and Figures, Conclusion, etc;
4. Only original papers will be considered. the manuscripts must not be previously published or accepted for publication elsewhere.

Submission System

<https://cmt3.research.microsoft.com/ISEEIE2023>

Registration Fee

Student(regular) 550 USD
Nonmember(regular) 500 USD

Key Dates

Paper submission due Feb. 3, 2023
Author Notification Mar. 20, 2023
Registration Apr. 20, 2023
Final paper submission due May 2, 2023

Conference Organizers

- Beijing University Of Technology
- Nipissing University, Canada



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